



Material Content Data Sheet



Sales Product Name		IPD70R600P7S		Issued		25. January 2018		
MA#		MA001501954						
Package		PG-TO252-3-344		Weight*		322.06 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.674	0.52	0.52	5197	5197
leadframe	inorganic material	phosphorus	7723-14-0	0.043	0.01		134	
	non noble metal	iron	7439-89-6	0.144	0.04		447	
	non noble metal	copper	7440-50-8	143.904	44.71	44.76	446824	447405
	non noble metal	aluminium	7429-90-5	0.449	0.14	0.14	1395	1395
wire	non noble metal	aluminium	7429-90-5	0.449	0.14	0.14	1395	1395
encapsulation	organic material	carbon black	1333-86-4	0.685	0.21		2128	
	plastics	epoxy resin	-	18.502	5.74		57449	
	inorganic material	silicondioxide	60676-86-0	117.864	36.60	42.55	365970	425547
leadfinish	non noble metal	tin	7440-31-5	3.834	1.19	1.19	11903	11903
solder	non noble metal	tin	7440-31-5	0.038	0.01		119	
	noble metal	silver	7440-22-4	0.048	0.01		149	
	non noble metal	lead	7439-92-1	1.836	0.57	0.59	5702	5970
heatspreader	inorganic material	phosphorus	7723-14-0	0.010	0.00		31	
	non noble metal	iron	7439-89-6	0.033	0.01		103	
	non noble metal	copper	7440-50-8	32.995	10.24	10.25	102449	102583
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com